

Approved : Yoshimichi Hirokawa
Yoshimichi HirokawaPrepared : Hiroyuki Syoji
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| No. | Test Item | Testing conditions | Conditions of acceptability | Number of samples | Number of failures |
|-----|---|---|---|-------------------|--------------------|
| 1 | Heat cycle test | (1) -40° C ~ 125° C 30minutes each (2) 800cycles | (1)No degradation of electric characteristics after test. (2)No crack at solder joint. | 5 | 0 |
| 2 | High temperature/ High humidity bias test | (1) Ta=85°C, RH=85% (2) At rated input (3) Load 0% (4) 500hours | (1)No degradation of electric characteristics after test. | 3 | 0 |
| 3 | Vibration test | (1) f=10~55Hz, 49.0m/s ² (5G) (2) 3minutes period (3) 60minutes each X, Y and Z axis | (1)No degradation of electric characteristics after test. (2)No crack at solder joint. (3)No mechanical damage of appearance. | 3 | 0 |
| 4 | Impact test | (1) 196.1m/s ² (20G), 11ms (2) Once each X, Y and Z axis | (1)No degradation of electric characteristics after test. (2)No crack at solder joint. (3)No thermal damage of appearance. | 3 | 0 |
| 5 | Soldering heat test | (1) Soldering iron 260°C, 15 seconds (2) Mounting board : t=1.6mm / FR4 | (1)No crack at solder joint. (2)No marked damage of appearance. | 1 | 0 |
| 6 | Pin strength test | (1) Weight : 1.0kg (2) Bending angle : 90 deg., total 180 deg. (3) 1 cycle | (1)No degradation of electric characteristics after test. (2)No degradation of terminal | 1 | 0 |
| 7 | Static electricity immunity test | (1) Applied voltage ±8kV (2) At rated input and load | (1)No protection circuit fail. (2)No output voltage drop with control circuit fail. (3)No any other function fail. | 1 | 0 |